

P-Channel Enhancement Mode Power MOSFET

Description

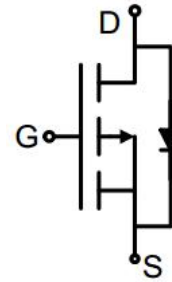
The GT6K2P10IH uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

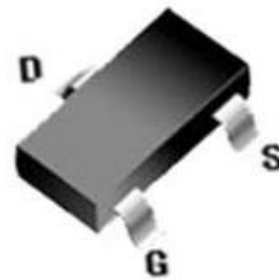
- V_{DS} -100V
- I_D (at $V_{GS} = -10V$) -1A
- $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 670m Ω
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



SOT-23

Ordering Information

| Device | Package | Marking | Packaging |
|------------|---------|----------|--------------|
| GT6K2P10IH | SOT-23 | GT6K2P10 | 3000pcs/Reel |

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

| Parameter | Symbol | Value | Unit |
|--------------------------------------------------|----------------|------------|------------------|
| Drain-Source Voltage | V_{DS} | -100 | V |
| Continuous Drain Current | I_D | -1 | A |
| Pulsed Drain Current (note1) | I_{DM} | -4 | A |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Power Dissipation | P_D | 1.4 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 To 150 | $^\circ\text{C}$ |

Thermal Resistance

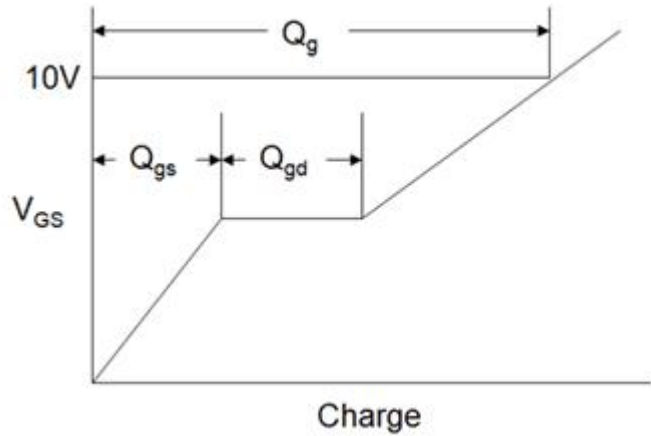
| Parameter | Symbol | Value | Unit |
|-----------------------------------------|------------|-------|--------------------|
| Thermal Resistance, Junction-to-Ambient | R_{thJA} | 89 | $^\circ\text{C/W}$ |

| Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted | | | | | | |
|------------------------------------------------------------------|---------------|-----------------------------------------------------------|-------|-------|-----------|------------|
| Parameter | Symbol | Test Conditions | Value | | | Unit |
| | | | Min. | Typ. | Max. | |
| Static Parameters | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -250\mu A$ | -100 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = -100V, V_{GS} = 0V$ | -- | -- | -1 | μA |
| Gate-Source Leakage | I_{GSS} | $V_{GS} = \pm 20V$ | -- | -- | ± 100 | nA |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = -250\mu A$ | -1.0 | -2.45 | -3.0 | V |
| Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS} = -10V, I_D = -1A$ | -- | 545 | 670 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS} = -5V, I_D = -1A$ | -- | 3 | -- | S |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0V,$ $V_{DS} = -50V,$ $f = 1.0\text{MHz}$ | -- | 253 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 24 | -- | |
| Reverse Transfer Capacitance | C_{rss} | | -- | 5 | -- | |
| Total Gate Charge | Q_g | $V_{DD} = -50V,$ $I_D = -1A,$ $V_{GS} = -10V$ | -- | 10 | -- | nC |
| Gate-Source Charge | Q_{gs} | | -- | 1 | -- | |
| Gate-Drain Charge | Q_{gd} | | -- | 4 | -- | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD} = -50V,$ $I_D = -1A,$ $R_G = 6\Omega$ | -- | 4 | -- | ns |
| Turn-on Rise Time | t_r | | -- | 5 | -- | |
| Turn-off Delay Time | $t_{d(off)}$ | | -- | 16 | -- | |
| Turn-off Fall Time | t_f | | -- | 44 | -- | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Body Diode Current | I_S | $T_C = 25^\circ\text{C}$ | -- | -- | -1 | A |
| Body Diode Voltage | V_{SD} | $T_J = 25^\circ\text{C}, I_{SD} = 1A, V_{GS} = 0V$ | -- | -- | -1.2 | V |
| Reverse Recovery Charge | Q_{rr} | $I_F = -1A, V_{GS} = 0V$ $di/dt = -100A/\mu s$ | -- | 157 | -- | nC |
| Reverse Recovery Time | T_{rr} | | -- | 60 | -- | ns |

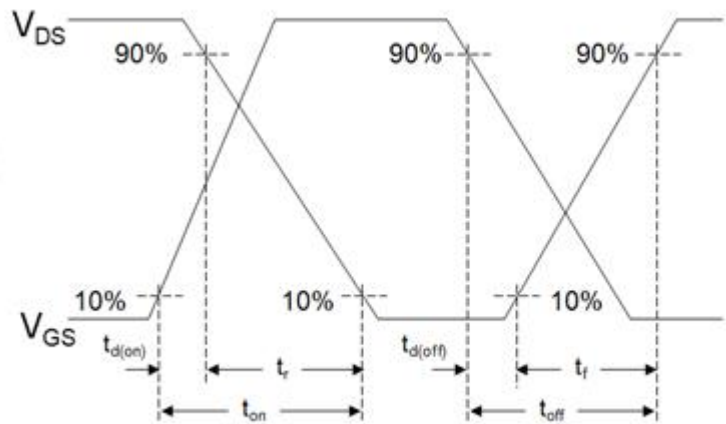
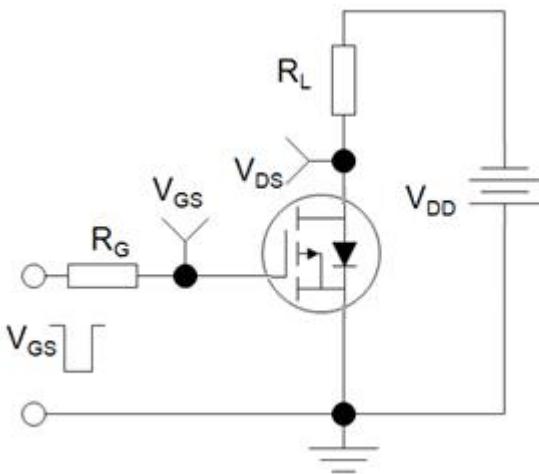
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

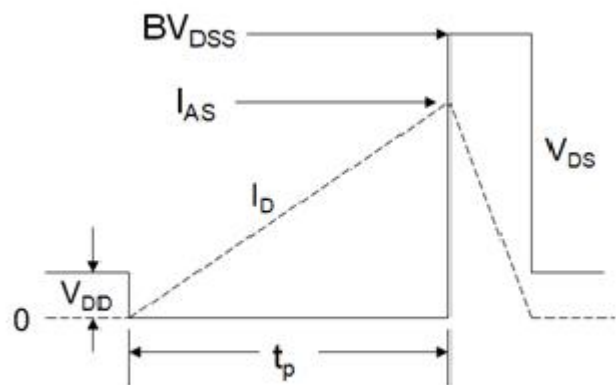
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

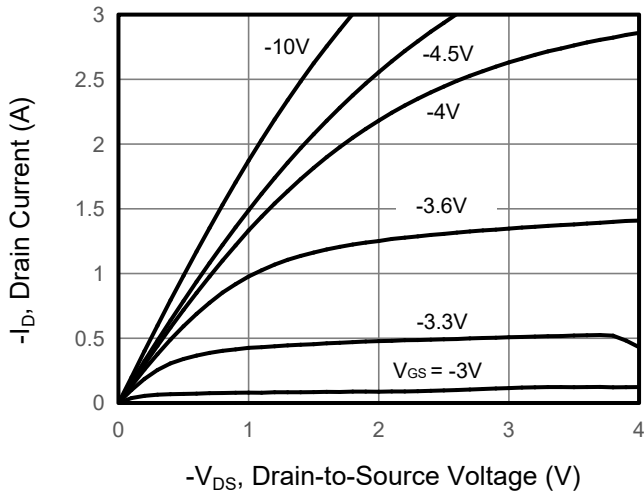


Figure 2. Transfer Characteristics

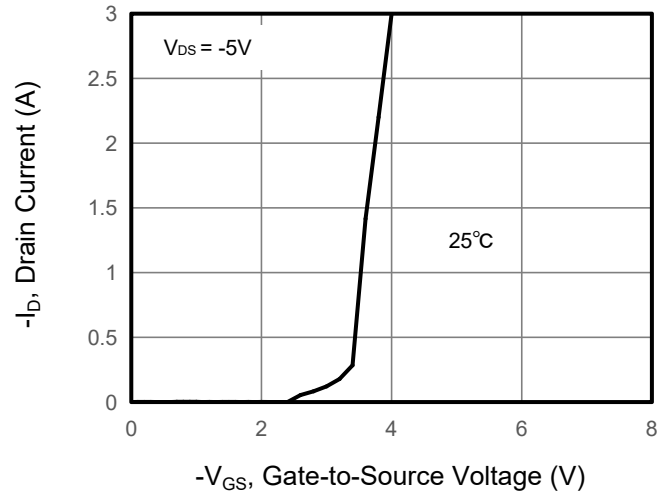


Figure 3. Drain Source On Resistance

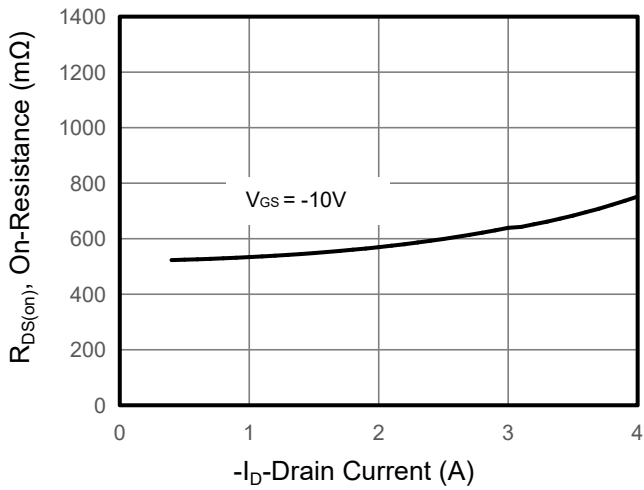


Figure 4. Gate Charge

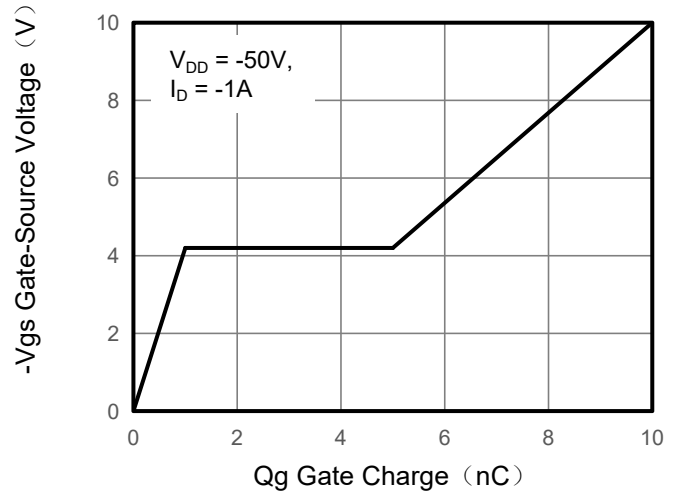


Figure 5. Capacitance

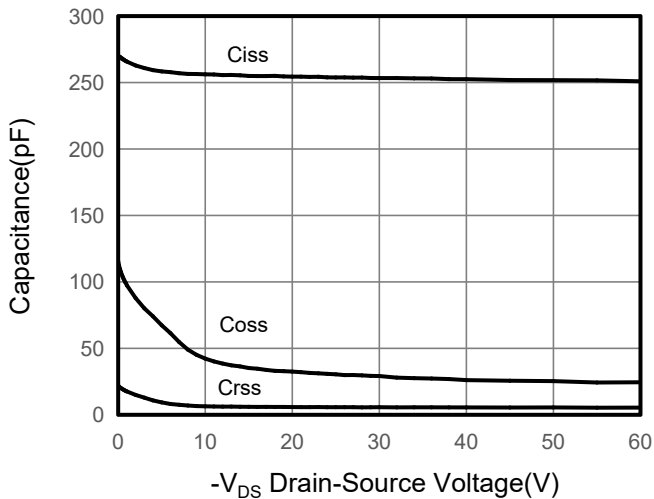
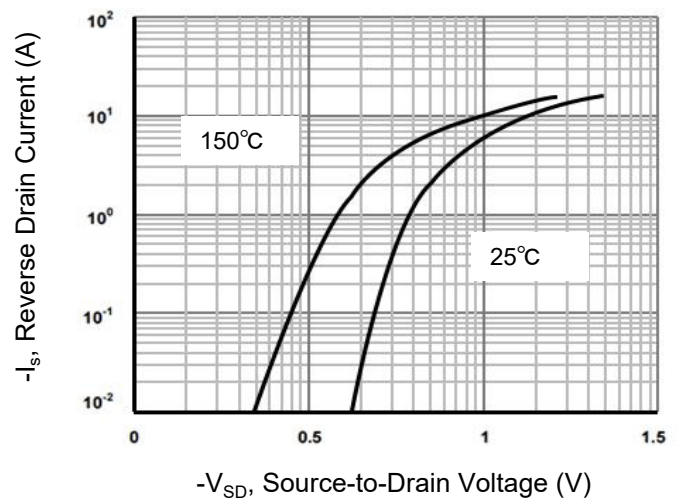


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

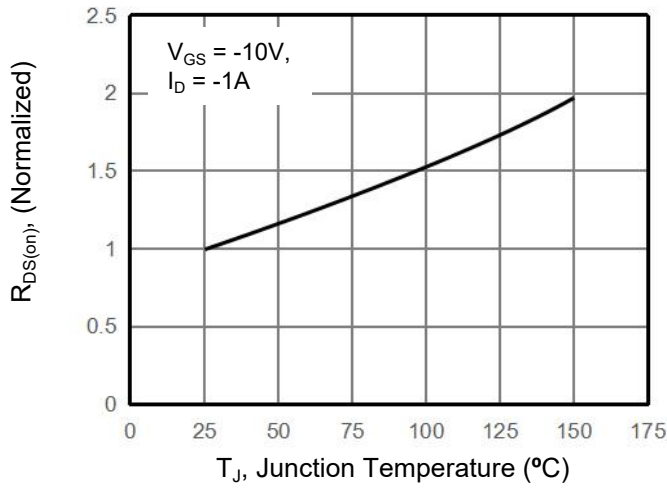


Figure 10. Safe Operation Area

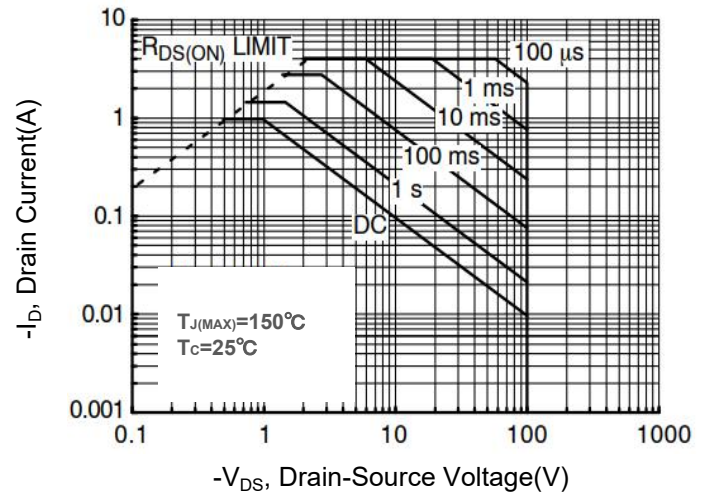
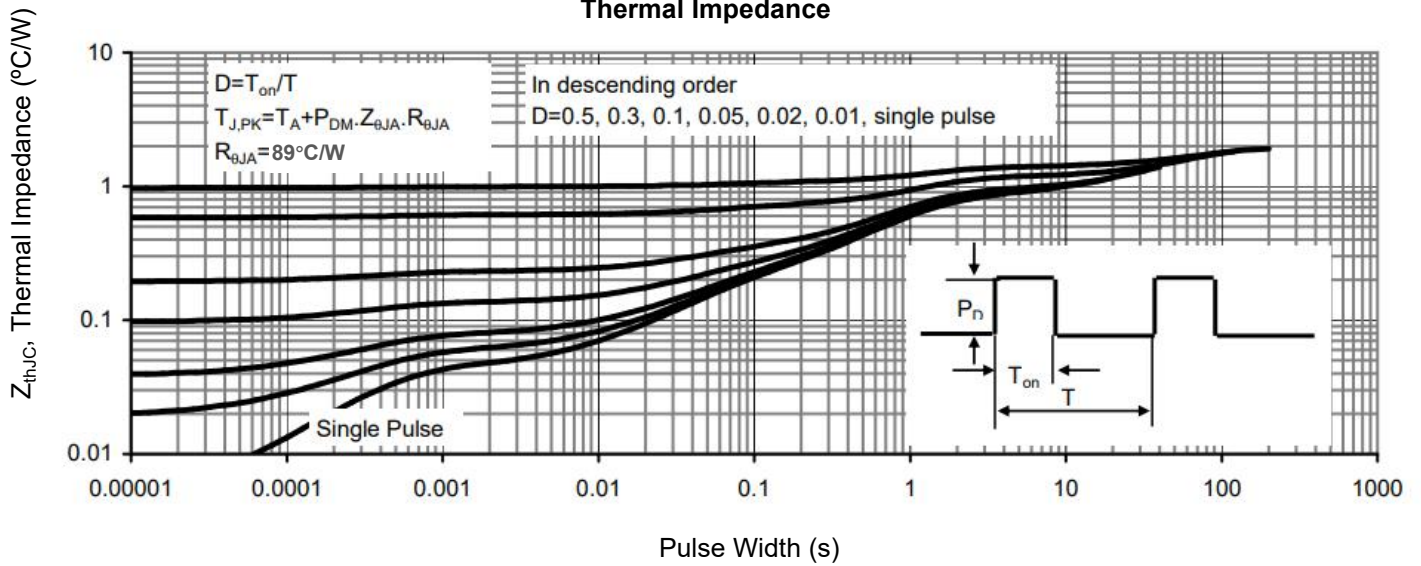
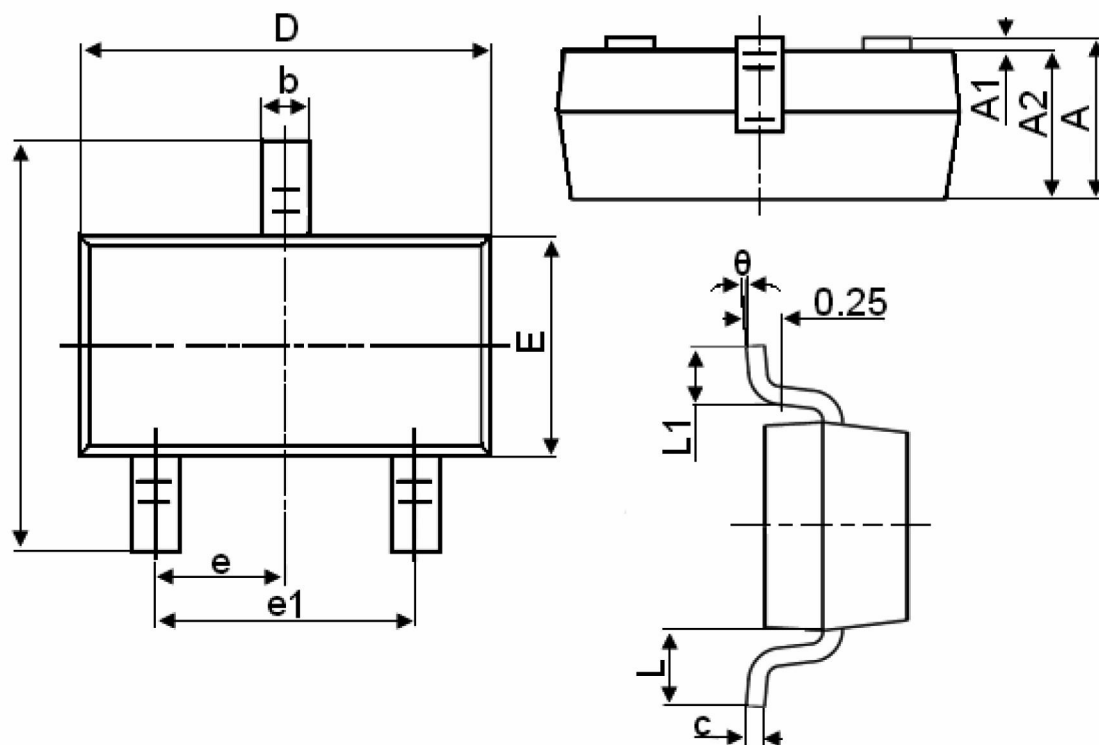


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



| Symbol | Dimensions in Millimeters | |
|----------|---------------------------|-----------|
| | MIN. | MAX. |
| A | 0.900 | 1.150 |
| A1 | 0.000 | 0.100 |
| A2 | 0.900 | 1.050 |
| b | 0.300 | 0.500 |
| c | 0.080 | 0.150 |
| D | 2.800 | 3.000 |
| E | 1.200 | 1.400 |
| E1 | 2.250 | 2.550 |
| e | 0.950TYP | |
| e1 | 1.800 | 2.000 |
| L | 0.550REF | |
| L1 | 0.300 | 0.500 |
| θ | 0° | 8° |

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